High-Gain IGBT w/ Diode

IXGP24N60C4D1

1.13/10

3

Nm/lb.in.

g

High-Speed PT Trench IGBT

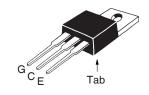


Symbol	Test Conditions	Maximum Ratings		
V _{CES}	T _{.1} = 25°C to 150°C	600	V	
V _{CGR}	$T_J^{\circ} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{GE} = 1\text{M}\Omega$	600	V	
V _{GES}	Continuous	±20	V	
V _{GEM}	Transient	±30	V	
I _{C25}	T _C = 25°C	56	A	
I _{C110}	$T_{\rm c} = 110^{\circ}$ C	24	Α	
I _{F110}	$T_{\rm c} = 110^{\circ}$ C	30	Α	
I _{CM}	$T_c = 25$ °C, 1ms	130	Α	
SSOA	$V_{GF} = 15V, T_{VI} = 125^{\circ}C, R_{G} = 10\Omega$	I _{CM} = 48	A	
(RBSOA)	Clamped Inductive Load	$@ \leq V_{CES}$		
P _c	T _C = 25°C	190	W	
T		-55 +150	°C	
T _{JM}		150	°C	
T _{stg}		-55 +150	°C	
T,	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C	

		cteristic Typ.	eristic Values Typ. Max.		
V _{GE(th)}	$I_{\rm C}=250\mu A,\ V_{\rm CE}=V_{\rm GE}$	4.0		6.5	V
I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$			10	μА
	$T_J = 125^{\circ}C$			1.5	mA
GES	$V_{CE}^{}=0V,V_{GE}^{}=\pm20V$			±100	nA
V _{CE(sat)}	$I_{c} = I_{c110}, V_{GE} = 15V, \text{ Note 1}$ $T_{J} = 125^{\circ}\text{C}$		2.10 1.95	2.70	V

 $egin{array}{lll} V_{\text{CES}} & = & 600V \\ I_{\text{C110}} & = & 24A \\ V_{\text{CE(sat)}} & \leq & 2.70V \\ t_{\text{fi(typ)}} & = & 44ns \\ \end{array}$

TO-220



G = Gate C = Collector E = Emitter Tab = Collector

Features

- Optimized for Low Switching Losses
- Square RBSOA
- Anti-Parallel Ultra Fast Diode
- International Standard Package

Advantages

- High Power Density
- Low Gate Drive Requirement

Applications

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts

Mounting Torque

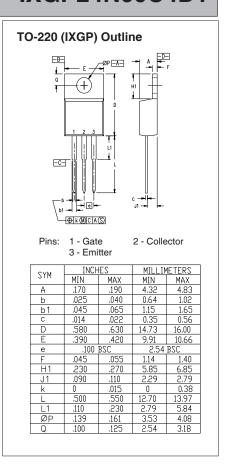
 M_{d}

Weight



IXGP24N60C4D1

	Symbol Test Conditions			Characteristic Values			
$(T_J = 2)$:5°C U	nless Otherwise Specified)	Min.	Тур.	Max.		
\mathbf{g}_{fs}		$I_{\rm C} = I_{\rm C110}, V_{\rm CE} = 10V, \text{ Note 1}$	10	17	S		
C _{ies})			875	pF		
C _{oes}	}	$V_{CE} = 25V$, $V_{GE} = 0V$, $f = 1MHz$		62	pF		
\mathbf{C}_{res}	J			28	pF		
Qq)			64	nC		
\mathbf{Q}_{ge}	}	$I_{\rm C} = I_{\rm C110}, V_{\rm GE} = 15 \rm V, V_{\rm CE} = 0.5 \bullet \rm V_{\rm CES}$		7	nC		
\mathbf{Q}_{gc}	J			28	nC		
t _{d(on)})			22	ns		
t _{ri}	1	Inductive Load, T _J = 25°C		43	ns		
E _{on}	\	$I_{\rm C} = I_{\rm C110}, V_{\rm GE} = 15V$		0.35	mJ		
$\mathbf{t}_{d(off)}$	- ($V_{CE} = 360V, R_{G} = 10\Omega$		192	ns		
t _{ri}		Note 2		44	ns		
E _{off}				0.34	0.60 mJ		
$\mathbf{t}_{d(on)}$)			20	ns		
t _{ri}		Inductive Load, T _J = 125°C		32	ns		
E _{on}	}	$I_{\rm C} = I_{\rm C110}, V_{\rm GE} = 15V$		0.37	mJ		
$\mathbf{t}_{d(off)}$		$V_{CE} = 360V$, $R_{G} = 10\Omega$		148	ns		
t _{fi}		Note 2		115	ns		
E _{off}				0.52	mJ		
R _{thJC}					0.65 °C/W		
R _{thCS}				0.21	°C/W		



Reverse Diode (FRED)

Symbo	ol Test Conditions Char	Characteristic Values		
$(T_J = 2)$	5°C, Unless Otherwise Specified) Min.	Тур.	Max.	
V _F	$I_F = 10A$, $V_{GE} = 0V$, Note 1		3.0	V
I _{RM}	$I_F = 12A, V_{GE} = 0V,$	2.5		Α
t _{rr}	\int -di _F /dt = 100A/µs, V _R = 100V, T _J = 125°C	110		ns
t _{rr}	$I_{_{\rm F}}=$ 1A, $V_{_{ m GE}}=$ 0V, $-di_{_{ m F}}/dt=$ 100A/ μ s, $V_{_{ m R}}=$ 30V	30		ns
R _{thJC}			2.5	°C/W

Notes:

- 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.
- 2. Switching times & energy losses may increase for higher V_{CE} (clamp), T_J or R_g .

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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